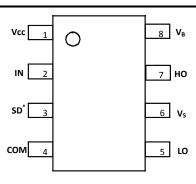


## **Pin Diagrams**

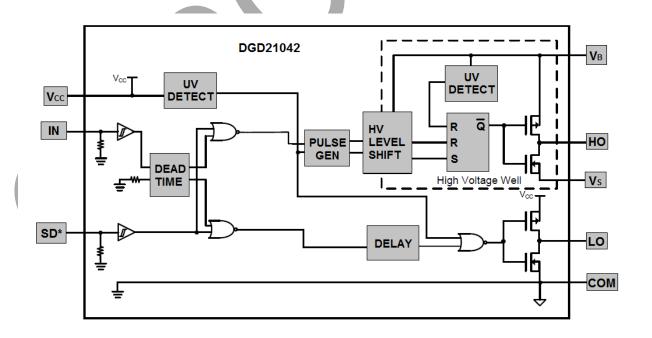


Top View: SO-8 (Type TH)

# **Pin Descriptions**

Pin Number	Pin Name	Function		
1	V <sub>CC</sub>	Logic and Low Side Supply		
2	IN	Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO		
3	SD*	Logic input for Shutdown, Enabled Low		
4	COM	Low-Side and Logic Return		
5	LO	Low-Side Gate Drive Output		
6	Vs	High-Side Floating Supply Return		
7	HO	High-Side Gate Drive Output		
8	VB	High-Side Floating Supply		

# Functional Block Diagram





#### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	VB	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V <sub>B</sub> -24 to V <sub>B</sub> +0.3	V
High-Side Floating Output Voltage	V <sub>HO</sub>	V <sub>S</sub> -0.3 to V <sub>B</sub> +0.3	V
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns
Low-Side Fixed Supply Voltage	V <sub>CC</sub>	-0.3 to +24	V
Low-Side Output Voltage	V <sub>LO</sub>	-0.3 to V <sub>CC</sub> +0.3	V
Logic Input Voltage (IN and SD*)	V <sub>IN</sub>	-0.3 to V <sub>CC</sub> +0.3	V

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

# Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	VB	V <sub>S</sub> + 10	V <sub>S</sub> + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High Side Floating Output Voltage	V <sub>HO</sub>	Vs	VB	V
Low Side Fixed Supply Voltage	Vcc	10	20	V
Low Side Output Voltage	VLO	0	Vcc	V
Logic Input Voltage (IN and SD*)	VIN	0	5	V
Ambient Temperature	TA	-40	+125	°C

Note: 6. Logic operation for  $V_S$  of -5V to +600V. Logic state held for  $V_S$  of -5V to - $V_{BS.}$ 





## **DC Electrical Characteristics** (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, @T<sub>A</sub> = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Logic "1" (IN) & Logic "0" (SD*) Input Voltage (Note 8)	V <sub>IH</sub>	2.5	_	_	V	V <sub>CC</sub> = 10V to 20V
Logic "0" (IN) & Logic "1" (SD*) Input Voltage (Note 8)	V <sub>IL</sub>	_	_	0.8	V	V <sub>CC</sub> = 10V to 20V
High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub>	V <sub>OH</sub>	-	0.05	0.2	V	$I_0 = 2mA$
Low Level Output Voltage, Vo	V <sub>OL</sub>	-	0.02	0.1	V	$I_0 = 2mA$
Offset Supply Leakage Current	I <sub>LK</sub>	-	I	50	μA	$V_{\rm B} = V_{\rm S} = 600 V$
Quiescent V <sub>BS</sub> Supply Current	I <sub>BSQ</sub>	-	60	100	μA	$V_{IN} = 0V \text{ or } 5V$
Quiescent V <sub>CC</sub> Supply Current	ICCQ	_	350	500	μA	V <sub>IN</sub> = 0V or 5V
Logic "1" Input Bias Current	I <sub>IN+</sub>	-	3.0	10	μA	V <sub>IN</sub> = 5V, SD* = 0V
Logic "0" Input Bias Current	I <sub>IN-</sub>	_	-	5.0	μA	V <sub>IN</sub> = 0V, SD* = 5V
V <sub>CC</sub> Supply Undervoltage Positive Going Threshold	V <sub>CCUV+</sub>	7.4	8.5	9.6	V	-
V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	V <sub>CCUV-</sub>	7.1	7.8	8.8	V	-
V <sub>BS</sub> Supply Undervoltage Positive Going Threshold	V <sub>BSUV+</sub>	5.5	6.5	7.5	V	-
V <sub>BS</sub> Supply Undervoltage Negative Going Threshold	V <sub>BSUV-</sub>	5.3	6.3	7.3	V	-
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	130	290	-	mA	V <sub>O</sub> = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	Io-	270	600	-	mA	Vo = 15V, PW ≤ 10µs

7. The V<sub>IN</sub> and I<sub>IN</sub> parameters are applicable to the two logic pins: IN and SD\*. The V<sub>0</sub> and I<sub>0</sub> parameters are applicable to the respective output pins: HO and LO.

 For optimal operation, it is recommended that the input pulses (IN and SD\*) should have an minimum amplitude of 2.5V with a minimum pulse width of 860ns.

## AC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, C<sub>L</sub> = 1000pF, @T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Turn-On Propagation Delay	ton	1	680	820	ns	$V_{\rm S} = 0V$
Turn-Off Propagation Delay	t <sub>OFF</sub>	-	150	220	ns	V <sub>S</sub> = 600V
Shutdown Propagation Delay	t <sub>SD</sub>	-	160	220	ns	-
Delay Matching, HO and LO Turn-On / Turn-Off	t <sub>DM</sub>	+	-	60	ns	_
Turn-On Rise Time	t <sub>R</sub>	-	70	170	ns	$V_{\rm S} = 0V$
Turn-Off Fall Time	tF	_	35	90	ns	$V_{\rm S} = 0V$
Deadtime: t <sub>DT LO-HO</sub> & t <sub>DT HO-LO</sub>	t <sub>DT</sub>	300	430	550	ns	-



Note:



## **Timing Waveforms**

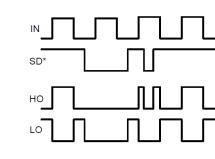


Figure 1. Input / Output Timing Diagram

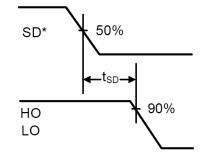
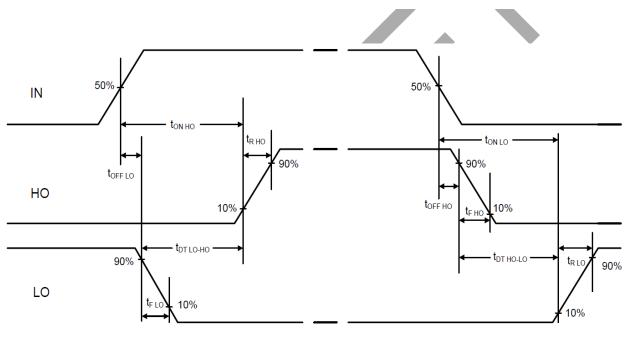
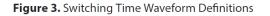


Figure 2. Shutdown Waveform Definition



 $\begin{array}{l} \text{Deadtime } t_{\text{DT LO-HO}} = t_{\text{ON HO}} \text{-} t_{\text{OFF LO}} \\ t_{\text{DT HO-LO}} = t_{\text{ON LO}} \text{-} t_{\text{OFF HO}} \end{array}$ 

Deadtime matching t<sub>MDT</sub> = t<sub>DT LO-HO</sub> - t<sub>DT HO-LO</sub>  $\begin{array}{l} \mbox{Delay matching} \\ t_{\mbox{DM OFF}} = t_{\mbox{OFF LO}} - t_{\mbox{OFF HO}} \\ t_{\mbox{DM ON}} = t_{\mbox{ON LO}} - t_{\mbox{ON HO}} \end{array}$ 





## Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.)

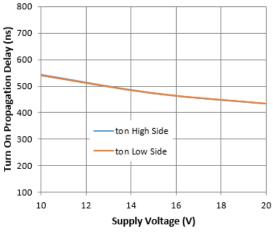


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

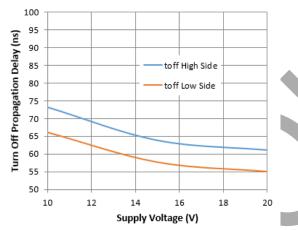


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

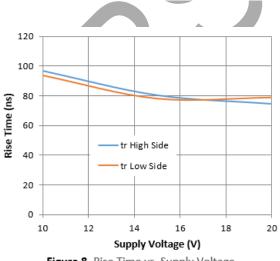


Figure 8. Rise Time vs. Supply Voltage

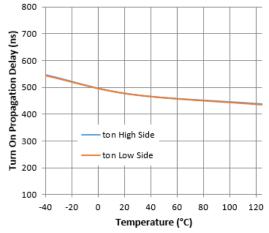


Figure 5. Turn-on Propagation Delay vs. Temperature

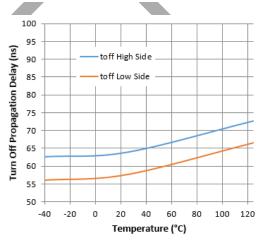
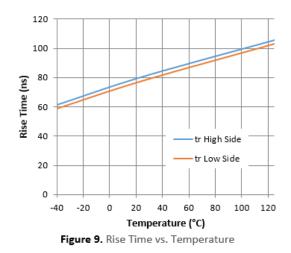


Figure 7. Turn-off Propagation Delay vs. Temperature





## Typical Performance Characteristics (continued)

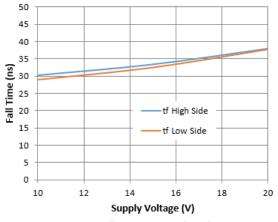


Figure 10. Fall Time vs. Supply Voltage

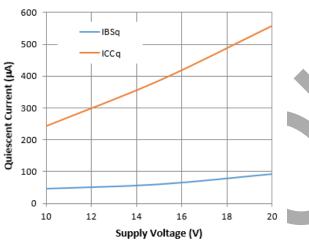


Figure 12. Quiescent Current vs. Supply Voltage

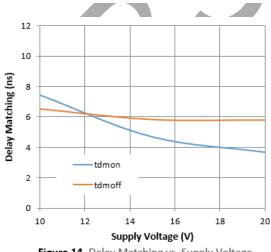
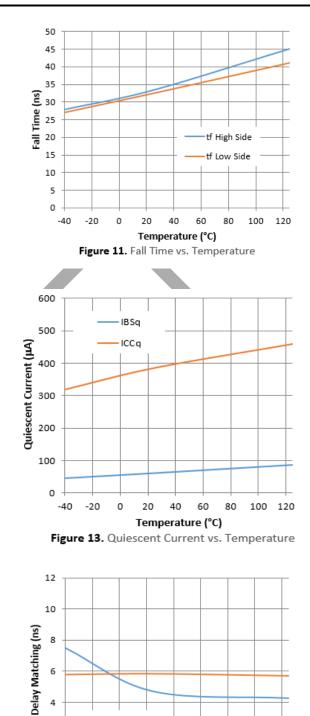


Figure 14. Delay Matching vs. Supply Voltage



4

2

0

-40 -20 0

tdmon

tdmoff

20

40

Figure 15. Delay Matching vs. Temperature

Temperature (°C)

60

80

100 120



## Typical Performance Characteristics (continued)

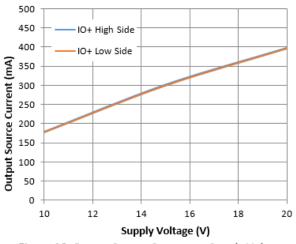


Figure 16. Output Source Current vs. Supply Voltage

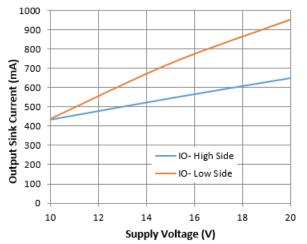
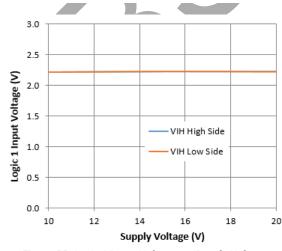


Figure 18. Output Sink Current vs. Supply Voltage





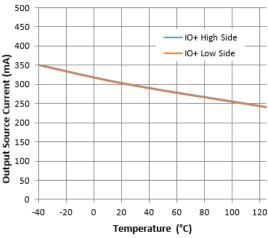
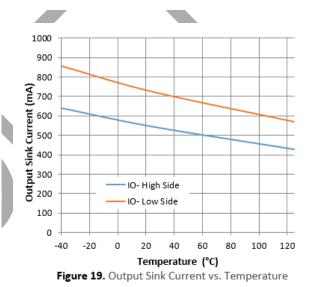


Figure 17. Output Source Current vs. Temperature



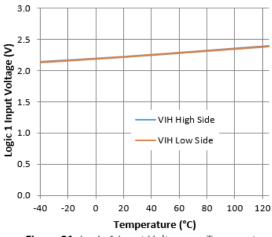
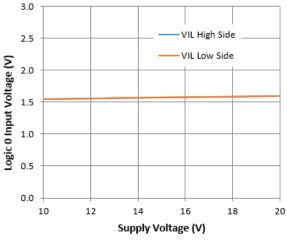


Figure 21. Logic 1 Input Voltage vs. Temperature



## Typical Performance Characteristics (continued)





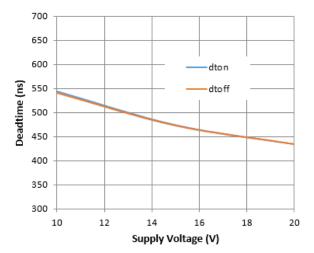
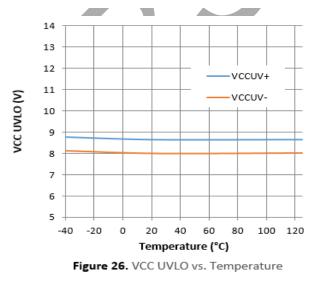


Figure 24. Deadtime vs. Supply Voltage



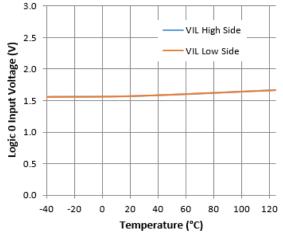


Figure 23. Logic 0 Input Voltage vs. Temperature

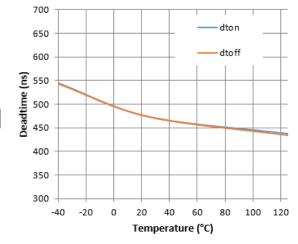


Figure 25. Deadtime vs. Temperature

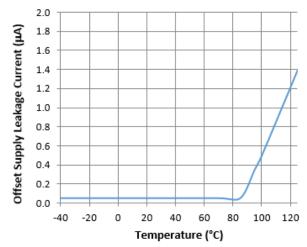


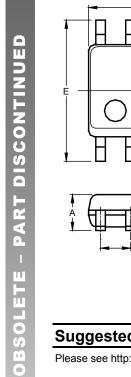
Figure 27. Offset Supply Leakage Current vs. Temperature



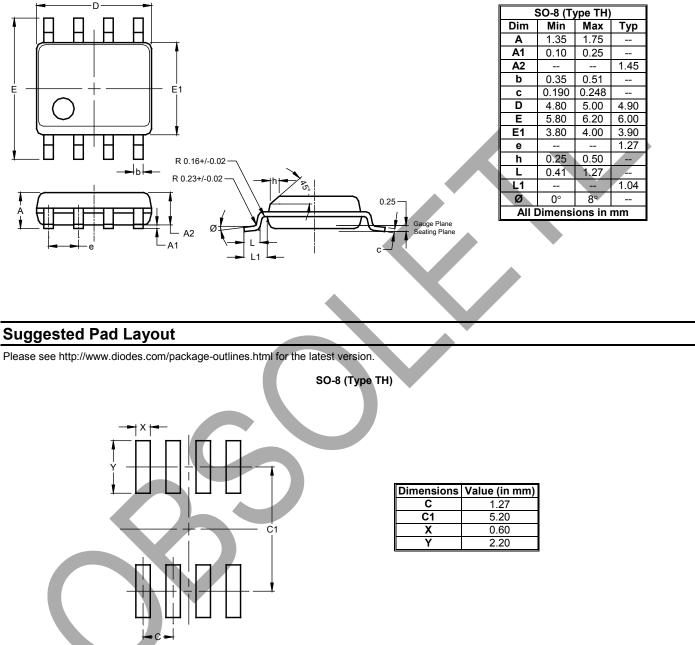
DGD21042

#### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.







Note : For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



#### IMPORTANT NOTICE

1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.

3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.

4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.

5. products provided subject to Diodes' Standard Terms and Conditions of Sale Diodes are (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.

7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.

8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

Copyright © 2021 Diodes Incorporated

www.diodes.com